

Current Transducer HY30-P

For the electronic measurement of currents : DC, AC, pulsed..., with a galvanic isolation between the primary circuit (high power) and the secondary circuit (electronic circuit).



Electrical data

Primary nominal r.m.s. current I_{PN} (A)	Primary current measuring range I_p (A)	Primary conductor (mm)	Type
30	± 90	2 x $\varnothing 1.5$ ¹⁾	HY 30-P

V_C	Supply voltage ($\pm 5\%$)	± 15	V
I_C	Current consumption	± 10	mA
\hat{I}_P	Overload capability (1 ms)	$50 \times I_{PN}$	
V_d	R.m.s. voltage for AC isolation test, 50/60Hz, 1 mn	2.5	kV
V_b	R.m.s. rated voltage, safe separation	500 ²⁾	V
R_{IS}	Isolation resistance @ 500 VDC	> 1000	M Ω
V_{OUT}	Output voltage @ $\pm I_{PN}$, $R_L = 10\text{ k}\Omega$, $T_A = 25^\circ\text{C} \pm 4$	V	
R_{OUT}	Output internal resistance	100	Ω
R_L	Load resistance	> 1	k Ω

Accuracy - Dynamic performance data

X	Accuracy @ I_{PN} , $T_A = 25^\circ\text{C}$ (without offset)	$< \pm 1$	%
ϵ_L	Linearity ³⁾ ($0 \dots \pm I_{PN}$)	$< \pm 1$	% of I_{PN}
V_{OE}	Electrical offset voltage, $T_A = 25^\circ\text{C}$	$< \pm 40$	mV
V_{OH}	Hysteresis offset voltage @ $I_p = 0$; after an excursion of $1 \times I_{PN}$	$< \pm 15$	mV
V_{OT}	Thermal drift of V_{OE}	typ. ± 1.5 max. ± 3	mV/K mV/K
TCE_G	Thermal drift of the gain (% of reading)	$< \pm 0.1$	%/K
t_r	Response time @ 90% of I_p	< 3	μs
di/dt	di/dt accurately followed	> 50	A/ μs
f	Frequency bandwidth ⁴⁾ (-3 dB)	DC .. 50	kHz

General data

T_A	Ambient operating temperature	- 10 .. + 80	$^\circ\text{C}$
T_S	Ambient storage temperature	- 25 .. + 85	$^\circ\text{C}$
m	Mass	< 14	g
	Standards ⁵⁾	EN 50178	

Notes : ¹⁾ Conductor terminals are soldered together.

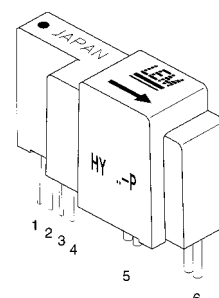
²⁾ Pollution class 2, overvoltage category III.

³⁾ Linearity data exclude the electrical offset.

⁴⁾ Please refer to derating curves in the technical file to avoid excessive core heating at high frequency.

⁵⁾ Please consult characterisation report for more technical details and application advice.

$$I_{PN} = 30\text{ A}$$



Features

- Hall effect measuring principle
- Galvanic isolation between primary and secondary circuit
- Isolation voltage 2500 V~
- Compact design for PCB mounting
- Low power consumption
- Extended measuring range ($3 \times I_{PN}$)
- Insulated plastic case recognized according to UL 94-V0.

Advantages

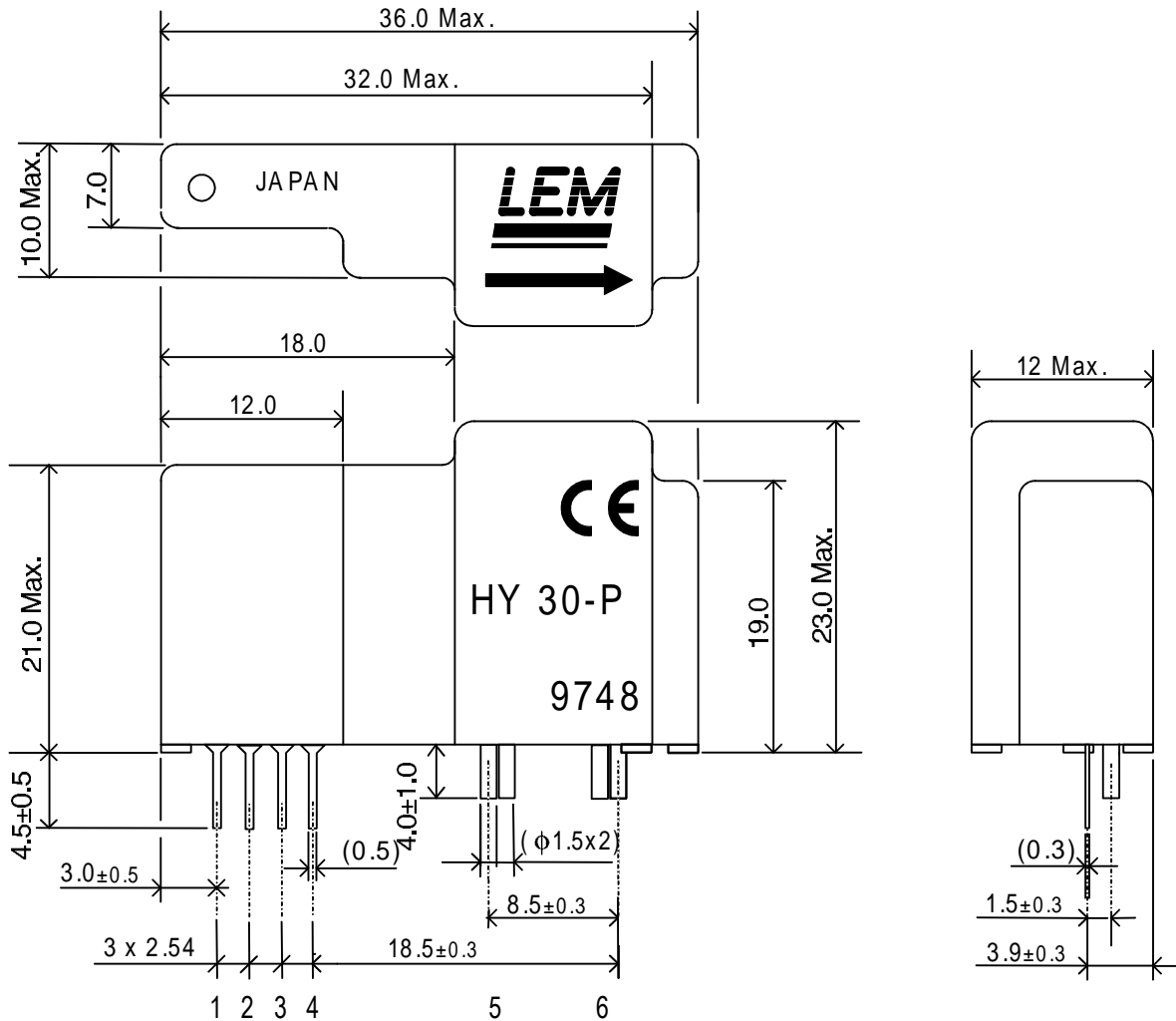
- Easy mounting
- Small size and space savings
- Only one design for wide current ratings range
- High immunity against external interference

Applications

- General purpose inverters
- Switched-Mode Power Supplies (SMPS)
- AC motor speed control
- Battery supplied applications
- Uninterruptible Power Supplies (UPS)
- Power supplies for welding applications.

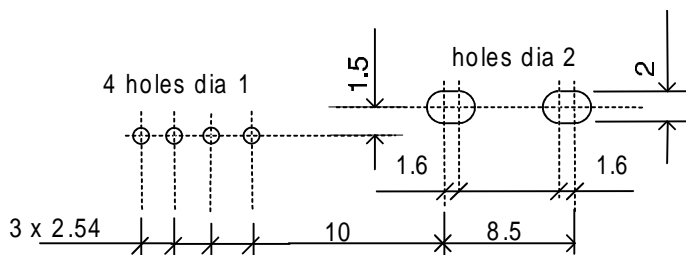
HY 30-P

Dimensions (in mm)



PCB MOUNTING DIMENSIONS (in mm ±0.1, hole -0, +0.2)

HY 30-P



PIN ARRANGEMENT

- 1 +15V
- 2 -15V
- 3 OUTPUT
- 4 0V

- 5 PRIMARY IN
- 6 PRIMARY OUT